

### Part Number: XZTHI54W

2.0x1.25mm INFRARED EMITTING DIODE

### Features

- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant



Package Schematics
0.13(0.005) Polarity mark
1.25(0.049) +
$\begin{array}{c} 1.3(0.051) \\ \hline 1.2(0.047) \end{array}$
0.5(0.02) $1.1(0.043)$ Max.
$\frac{0.4(0.016)}{1} \frac{0.4(0.016)}{1}$
Notes:
<ol> <li>All dimensions are in millimeters (inches).</li> <li>Tolerance is ±0.1(0.004") unless otherwise noted.</li> </ol>
3. Specifications are subject to change without notice.

Absolute Maximum Ratings THI Unit (T<sub>A</sub>=25°C) (GaAlAs) **Reverse Voltage**  $V_{R}$  $\mathbf{5}$ V Forward Current  $\mathbf{I}_{\mathbf{F}}$ 50mА Forward Current (Peak) 1/100 Duty Cycle 1200mА ifs 10us Pulse Width mW Power Dissipation  $\mathbf{P}_{\mathrm{D}}$ 85**Operating Temperature**  $T_A$  $\text{-}40 \sim +85$ °C Tstg  $-40 \sim +85$ Storage Temperature

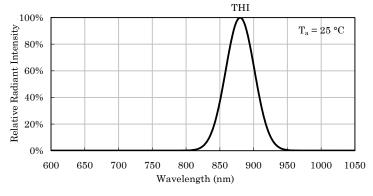
A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)	THI (GaAlAs)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	1.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	1.6	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	880*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle \lambda$	50	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	90	pF

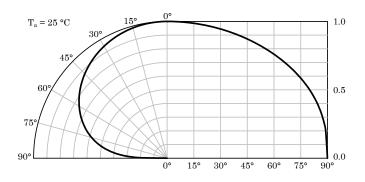
Part Number	Emitting Material	Lens-color	Radiant Intensity CIE127-2007* (Po=mW/sr) @20mA		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
			min.	typ.		
XZTHI54W	GaAlAs	Water Clear	0.8*	1.3*	880*	160°

\*Radiant intensity value and wavelength are in accordance with CIE127-2007 standards.



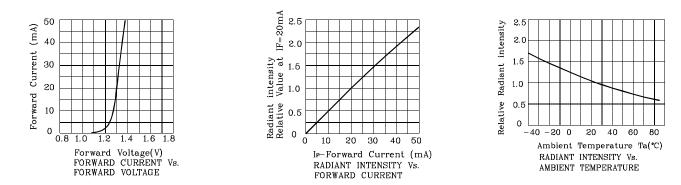


Relative Intensity Vs. CIE Wavelength

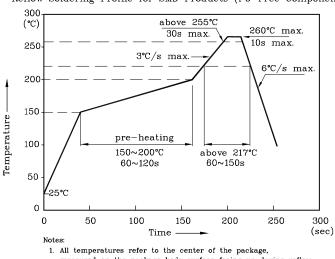


Spatial Distribution

### ♦ THI



# LED is recommended for reflow soldering and soldering profile is shown below.

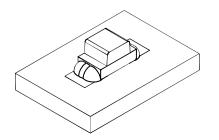


Reflow Soldering Profile for SMD Products (Pb-Free Components)

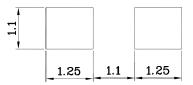
 All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
 Do not apply any stress to the LED during high temperature conditions.
 Maximum number of soldering passes: 2



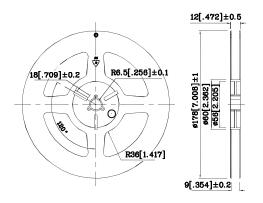
♦ The device has a single mounting surface. The device must be mounted according to the specifications.



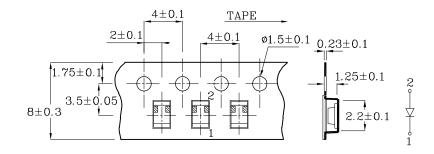
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



## Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage or radiant intensity / luminous flux),

the typical accuracy of the sorting process is as follows:

1. Radiant Intensity / Luminous Flux: +/-15%

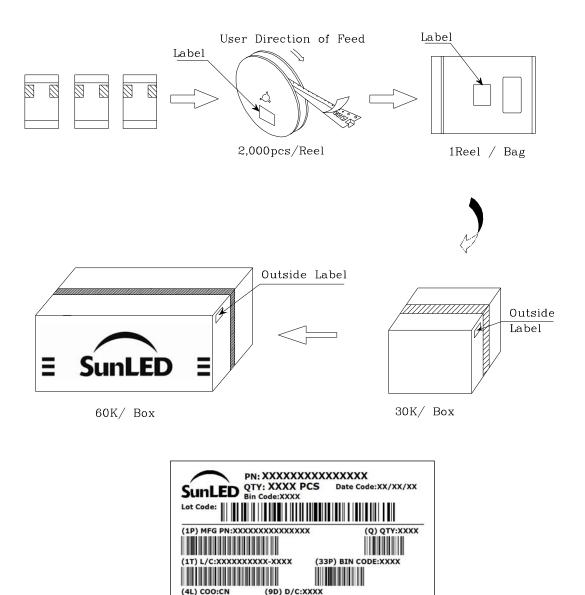
2. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters

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### PACKING & LABEL SPECIFICATIONS



RoHS Comp

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
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(SP)XXXXXXXXXXX

- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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